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Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	4mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
B	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
P	1.7mm REF
R	1mm REF
X	0.1mm +/-0.1mm REF

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

General Information

Series	T543 HRA
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Up Screening
Features	Non-Combustible, Low ESR, High Reliability
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov
SCIP Number	b064b03e-bd75-42af-b342-1fe94dec2340
Termination	Tin Lead (SnPb)
AEC-Q200	No
Typical Component Weight	588.16 mg
Shelf Life	52 Weeks
MSL	3

Specifications

Capacitance	47 uF
Capacitance Tolerance	10%
Voltage DC	35 VDC (105C), 23.45 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Humidity	60C, 90% RH, 500 Hours
Dissipation Factor	10% 120Hz 25C
Failure Rate	N/A
ESR	30 mOhms (100kHz)
Ripple Current	2869 mA (rms, 100kHz 45C)
Leakage Current	164.5 uA (5min 25°C)
Testing and Reliability	10 Cycles Surge Current Testing At -55C And +85C